

High Performance Stepper Motor Drive Circuit

FEATURES

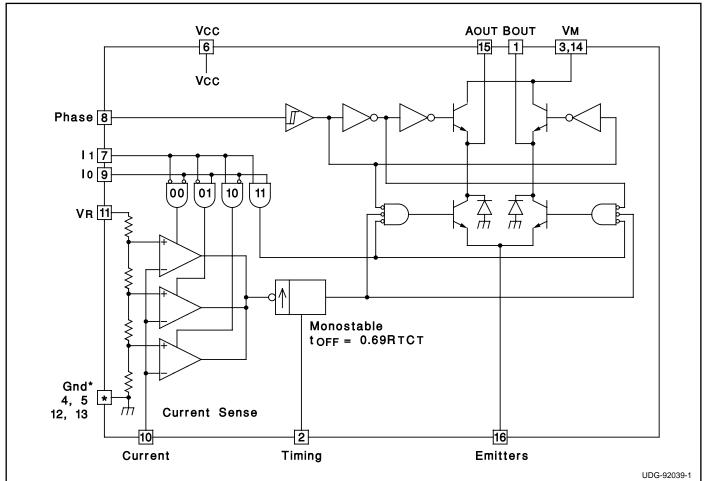
- Full-Step, Half-Step and Micro-Step Capability.
- Bipolar Output Current up to 2A.
- Wide Range of Motor Supply Voltage: 10–50V
- Low Saturation Voltage
- Wide Range of Current Control: 5mA–2A.
- Current Levels Selected in Steps or Varied Continuously.
- Thermal Protection and Soft Intervention.

DESCRIPTION

The UC3770A and UC3770B are high-performance full bridge drivers that offer higher current and lower saturation voltage than the UC3717 and the UC3770. Included in these devices are LS-TTL compatible logic inputs, current sense, monostable, thermal shutdown, and a power H-bridge output stage. Two UC3770As or UC3770Bs and a few external components form a complete microprocessor-controllable stepper motor power system.

Unlike the UC3717, the UC3770A and the UC3770B require external high-side clamp diodes. The UC3770A and UC3770B are identical in all regards except for the current sense thresholds. Thresholds for the UC3770A are identical to those of the older UC3717 permitting drop-in replacement in applications where high-side diodes are not required. Thresholds for the UC3770B are tailored for half stepping applications where 50%, 71%, and 100% current levels are desirable.

The UC3770A and UC3770B are specified for operation from 0°C to 70°C ambient.



BLOCK DIAGRAM

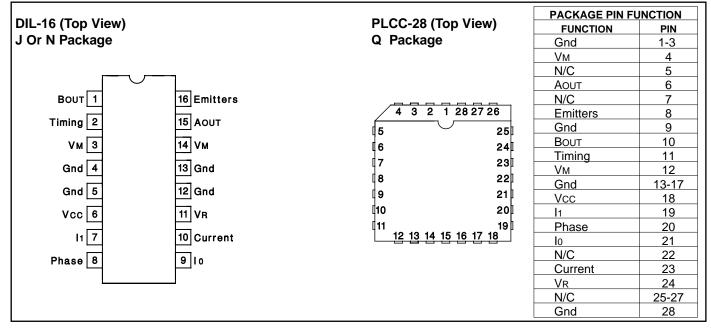
ABSOLUTE MAXIMUM RATINGS

Logic Supply Voltage, Vcc7V
Output Supply Voltage, VMM
Logic Input Voltage (Pins 7, 8, 9) 6V
Analog Input Voltage (Pin 10) Vcc
Reference Input Voltage (Pin 11)
Logic Input Current (Pins 7, 8, 9)–10mA
Analog Input Current (Pins 10, 11)–10mA
Output Current (Pins 1, 15) ± 2A
Junction Temperature, TJ+150°C

Note 1: All voltages are with respect to Gnd (DIL Pins 4, 5, 12, 13); all currents are positive into, negative out of the specified terminal. Note 2: Consult Unitrode Integrated Circuits databook for thermal limitations and

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CONNECTION DIAGRAMS



ELECTRICAL CHARACTERISTICS: (All tests apply with VM = 36V, VCC = 5V, VR = 5V, No Load, and $0^{\circ}C < TA < 70^{\circ}C$, unless otherwise stated, TA = TJ.)

		UC3770A			UC3770B			
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	MIN	ТҮР	MAX	UNITS
Supply Voltage Vм (Pins 3, 14)		10		45	10		45	V
Logic Supply Voltage Vcc (Pin 6)		4.75	5	5.3	4.75	5	5.3	V
Logic Supply Current Icc (Pin 6)	IO = I1 = H, IM = 0		15	25		15	25	mA
	IO = I1 = L, IM = 0		18	28		18	28	mA
	IO = I1 = H, IM = 1.3A		33	40		33	40	mA
Thermal Shutdown Temperature			+170			+170		°C
Logic Threshold (Pins 7, 8, 9)		0.8		2.0	0.8		2.0	V
Input Current Low (Pin 8)	VI = 0.4V			-100			-100	μA
Input Current Low (Pins 7, 9)	VI = 0.4V			-400			-400	μA
Input Current High (Pins 7, 8, 9)	VI = 2.4V			10			10	μA
Comparator Threshold (Pin 10)	VR = 5V, I0 = L, I1 = L	400	415	430	400	415	430	mV
	VR = 5V, I0 = H, I1 = L	240	255	265	290	300	315	mV
	VR = 5V, I0 = L, I1 = H	70	80	90	195	210	225	mV
Comparator Input Current (Pin 10)				±20			±20	μA
Off Time	RT = 56k, CT = 820pF	25	30	35	25	30	35	ms

UC3770A UC3770B

ELECTRICAL CHARACTERISTICS (cont.): (All tests apply with VM = 36V, VCC = 5V, VR = 5V, No Load, and $0^{\circ}C < TA < 70^{\circ}C$, unless otherwise stated, TA = TJ.)

		l	UC3770A			UC3770B		
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	MIN	ТҮР	MAX	UNITS
Turn Off Delay				2			2	ms
Sink Driver Saturation Voltage	IM = 1.0A			0.8			0.8	V
	IM = 1.3A			1.3			1.3	V
Source Driver Saturation Voltage	IM = 1.0A			1.3			1.3	V
	IM = 1.3A			1.6			1.6	V
Output Leakage Current	VM = 45V			100			100	μA

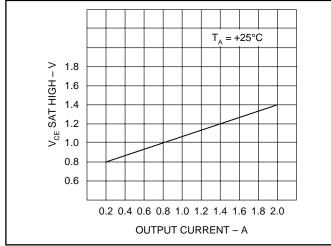


Figure 1. Typical source saturation voltages vs. load current

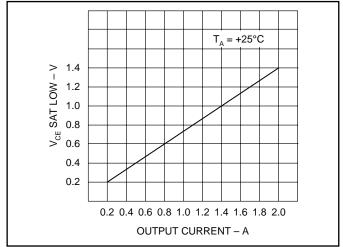


Figure 2. Typical sink saturation voltages vs. load current

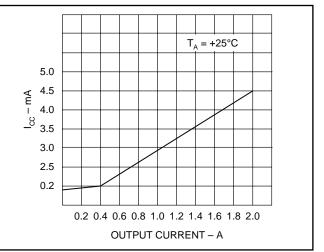


Figure 3. Typical supply current vs. load current.

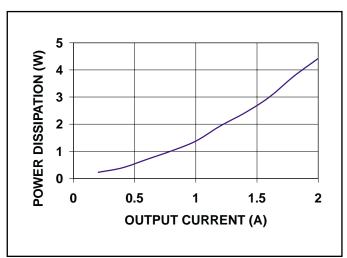


Figure 4. Typical power dissipation vs. output current.

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